

# APPROVAL SHEET

To :

Customer P/N :

UDE P/N : RU4-ZZ-0038

Description : RJ45 Tab up over USB 2.0 stack

Through Hole

5G Base-T

Contact Area : 30 $\mu$ " Min. Gold

LED : L-Green; R-Yellow



Spec No.  
RU417029-00

Update Date  
2017/6/7

Revision  
A

Approved	Checked	Prepared



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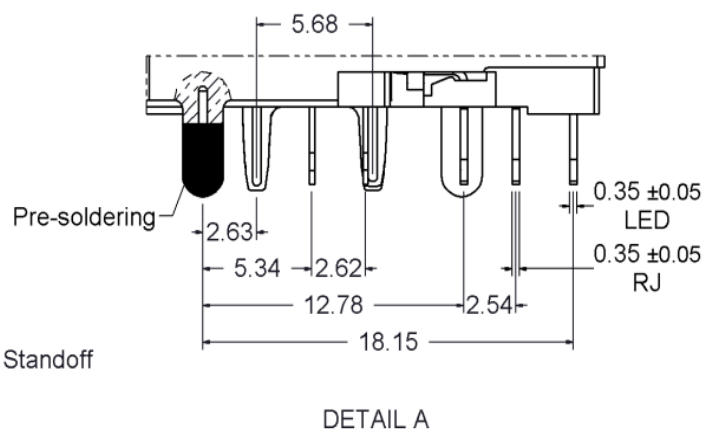
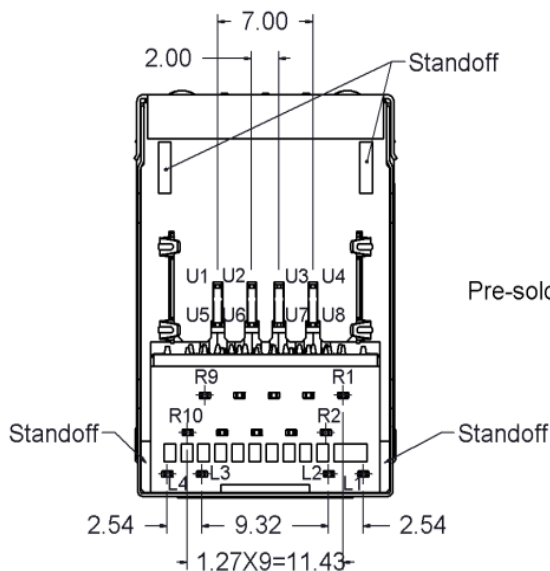
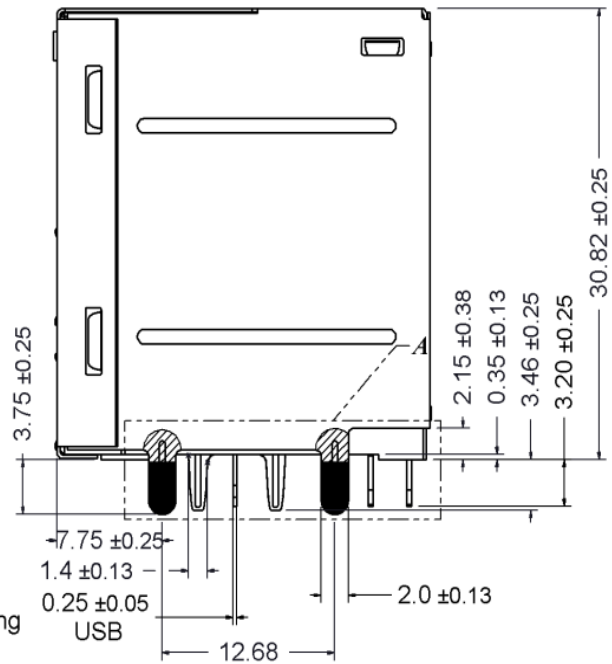
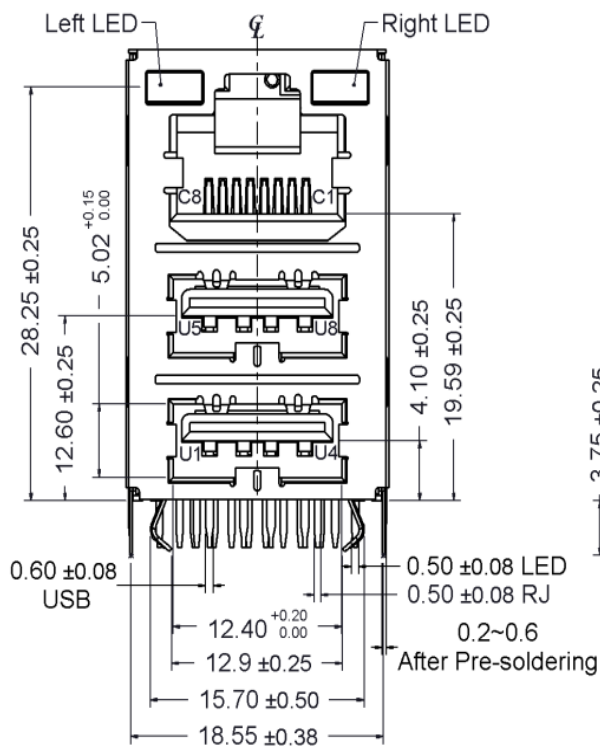
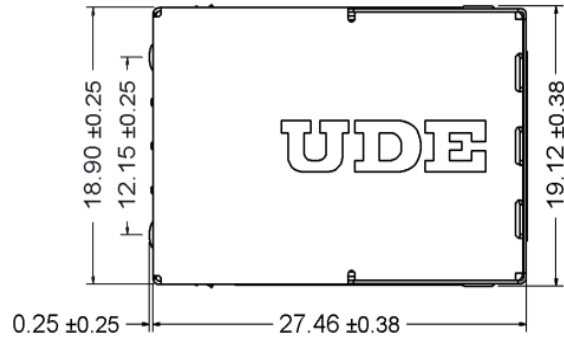
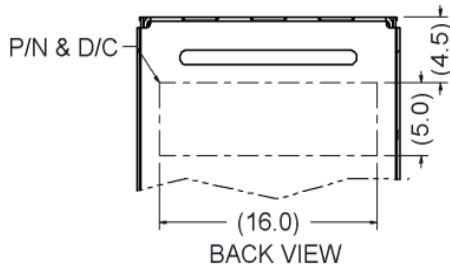
<http://www.ude-corp.com/>



1. MECHANICAL DIMENSION

Product Dimension

Unit:mm	General Tolerance :	X.X : ± 0.38
		X.XX : ± 0.20



Recommended PCB Layout. Component side of board

All dimension units are "mm".

All dimension tolerances are ±0.05mm unless otherwise specified.

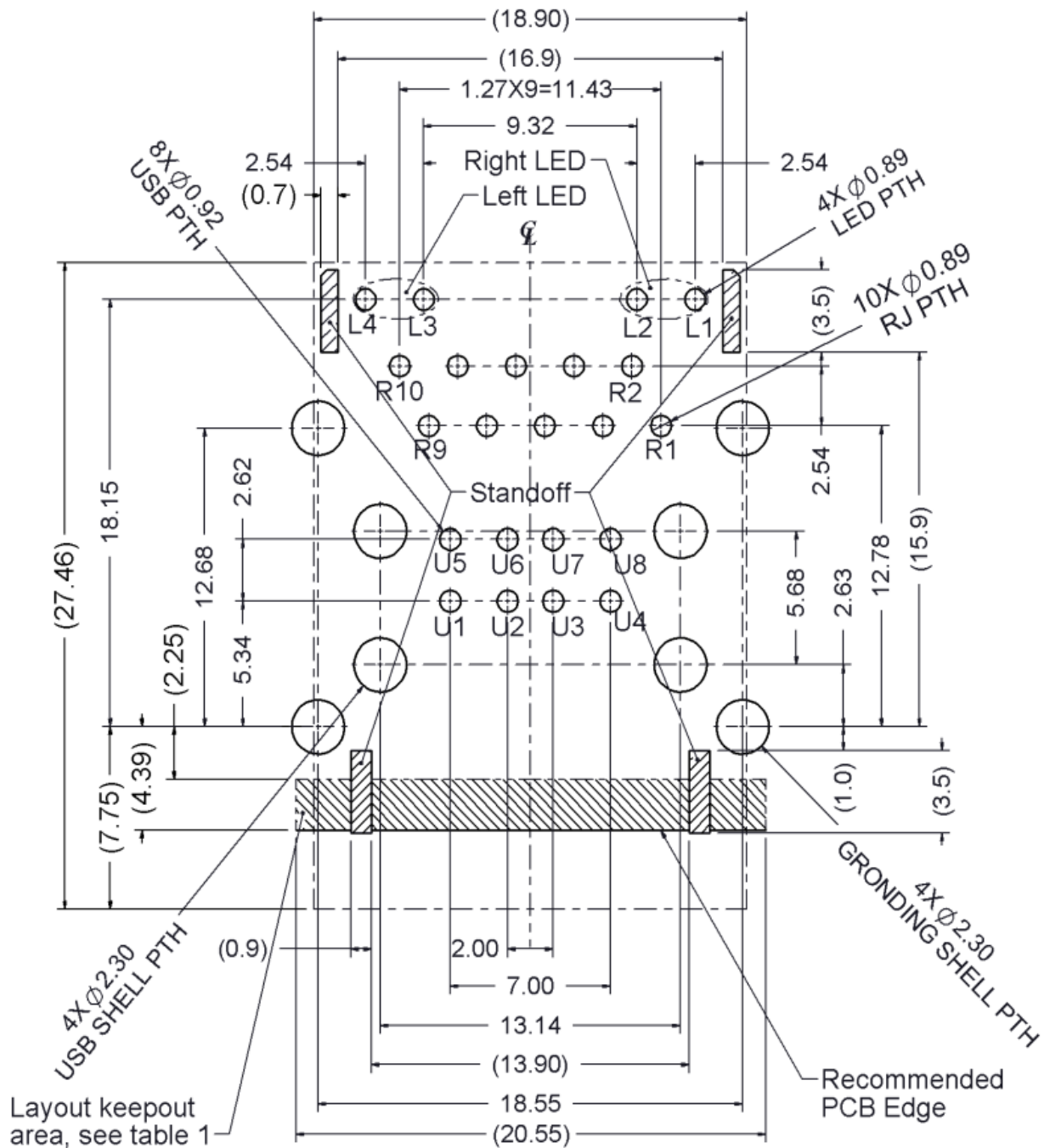
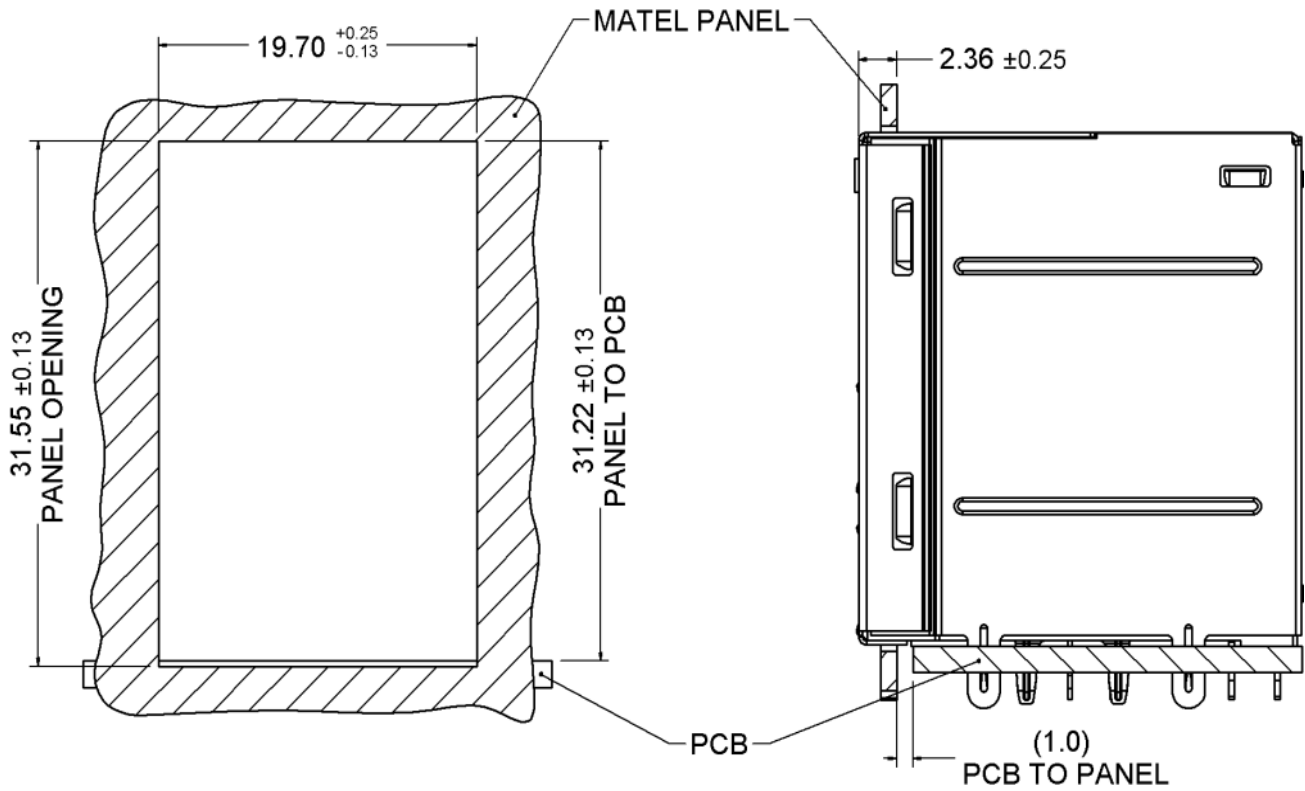


Table1

Layout Layer	Trace	component	Grounding	Test Point	Via Hole	PTH	NPTH
Component side	X	X	O	X	X	X	O
Inner layer	O	NA	O	NA	O	X	O
Bottom side	O	O	O	O	O	X	O

X--Forbid; O--OK; NA--Not Applicable.

Recommended Panel cutout



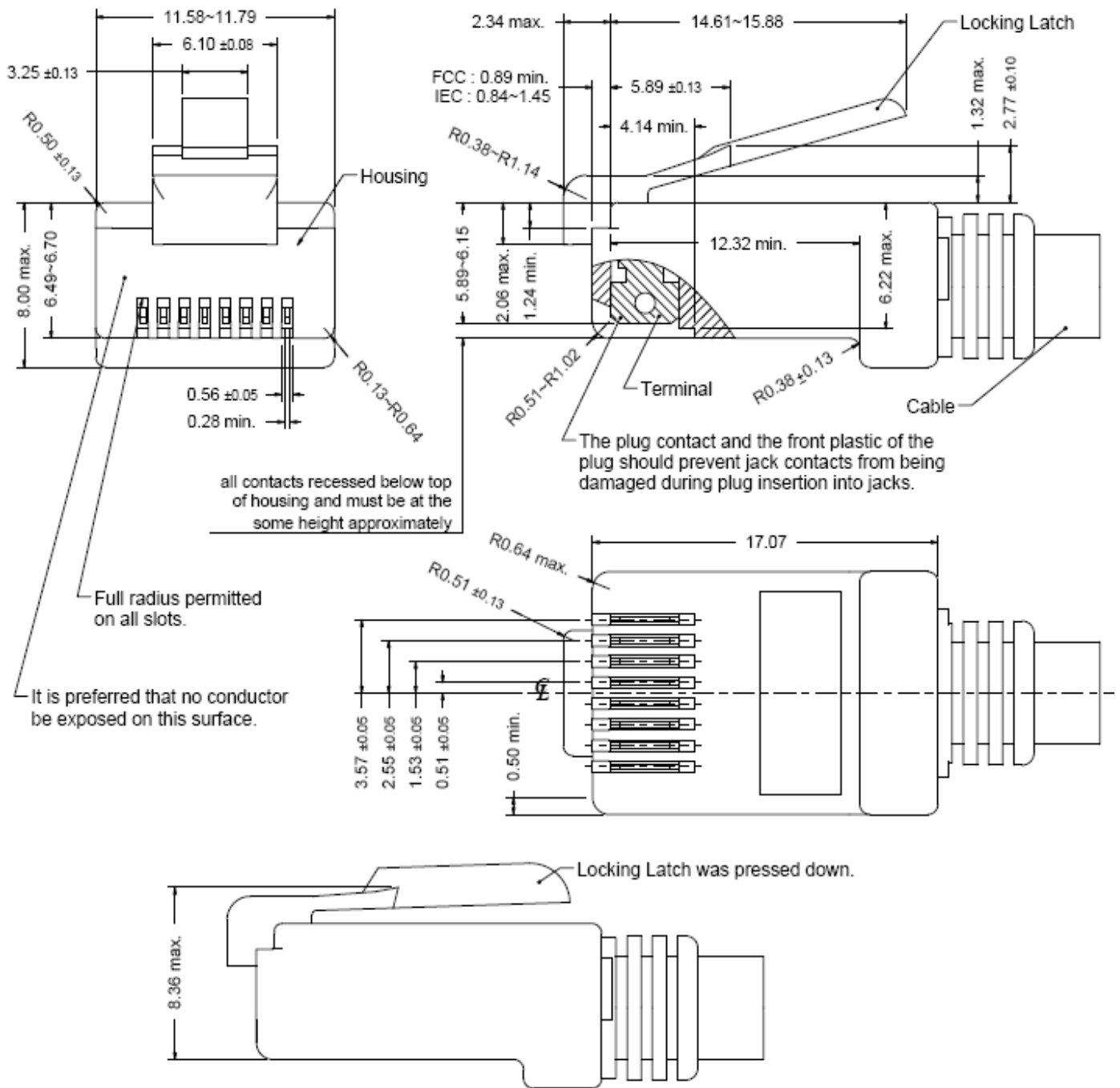
2. Packing Information

40 pcs finished goods per tray

5 trays(200 pcs finished goods) per inner box

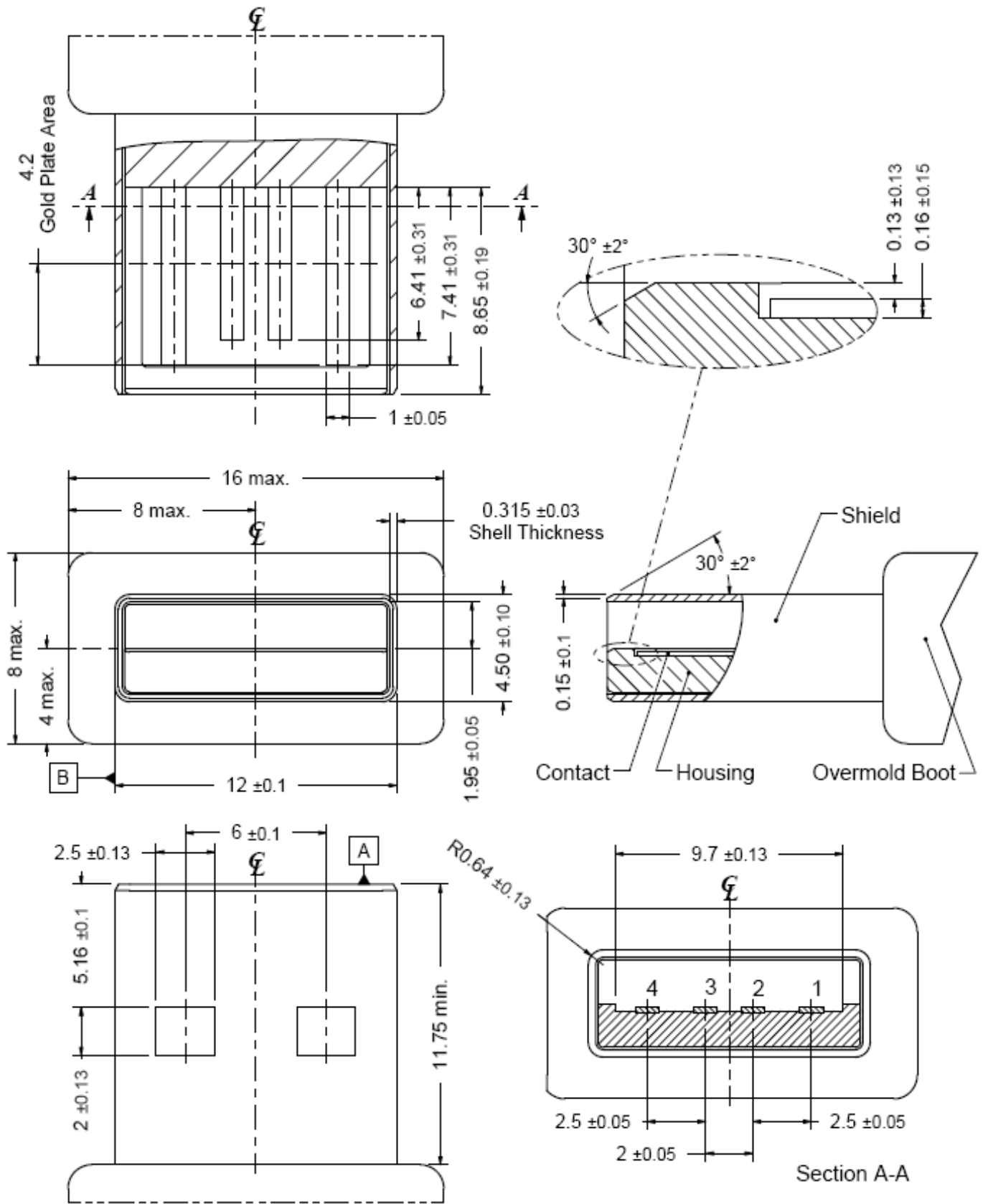
4 Inner boxes(800 pcs finished goods) per master carton

3. Standard RJ45 Plug Specification



- All dimensions follow :  
FCC subpart F, 68,500, Figure (C)(2)(i) & (C)(2)(ii) & (C)(3)(i)  
IEC 60603-7
- All plugs must be meeting the requirements of plug Go & No-Go gauge.  
Gauge follow : FCC subpart F, 68,500, Figure (C)(4)(i) & (C)(5)(i)
- There must be no damage to Housing and Locking Latch.
- There must be no nicks and cuts in cable.
- Durability : 750 cycles generally

### 4. Standard USB 2.0 Plug Specification



- All dimensions follow : Universal Series Bus Specification 2.0 (April 27,2000)  
Figure 6-9. USB Series A Plug Interface Drawing

## 5. REQUIREMENTS

### Design and Construction

Product shall be of design, construction and physical dimensions specified on applicable.

### Material

Terminal Parts (Underplating : 50 $\mu$ " min. Nickel overall)

RJ Terminal : Phosphor Bronze, Thickness=0.30mm

Finish Contact Area : 30 $\mu$ " min. Gold

USB Terminal : Phosphor Bronze, Thickness=0.25mm

Finish Contact Area : 30 $\mu$ " min. Gold

Solder Tail : 100 $\mu$ " min. Bright Tin

Input Terminal : Brass, Thickness=0.35mm

Finish : 100 $\mu$ " min. Bright Tin

Case Terminal : CP Wire, Diameter=0.40mm

Finish : 100 $\mu$ " min. Bright Tin

Plastic Parts <UL94V-0>

Housing : PBT, Black

Case : PF2A5-151J, Black

Spacer : PBT, Black

Shield Parts

Front Shield : stainless steel, Thickness=0.25mm, unplating

Back Shield : stainless steel, Thickness=0.20mm, Pre-soldering

USB Kink : Brass, Thickness=0.25mm

Finish : 100 $\mu$ " min. Tin over 30 $\mu$ " min. Nickel overall



## 6. Operating and Storage Temperature

Operating Temperature : 0°C to +70°C

Storage Temperature : -40°C to +85°C

## 7. RJ45 specifications

Insulation Resistance : 500MΩ min.

Insertion force with the latch depressed : 20N max.

Removal force with the latch depressed : 20N max.

Locking Force of Plug Latch : 50N min. @ 60+/-5 sec.

Durability : 2500 cycles

## 8. USB 2.0 specifications

Insulation Resistance : 1000MΩ min.

Dielectric Withstanding Voltage : 500Vac @1min.

Insertion force : 35N max.

Removal force : 10N min.

Durability : 1500 cycles

## 9. Performance and Test Description

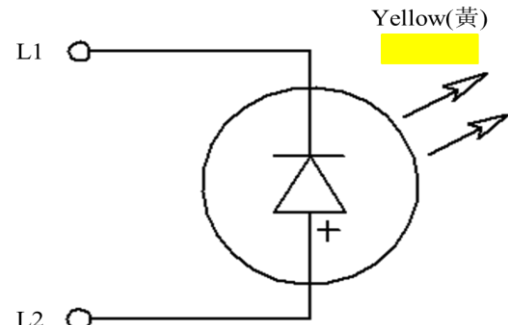
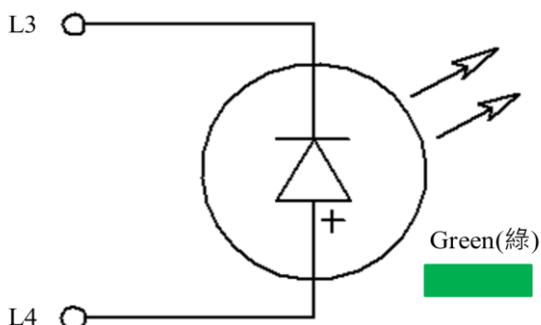
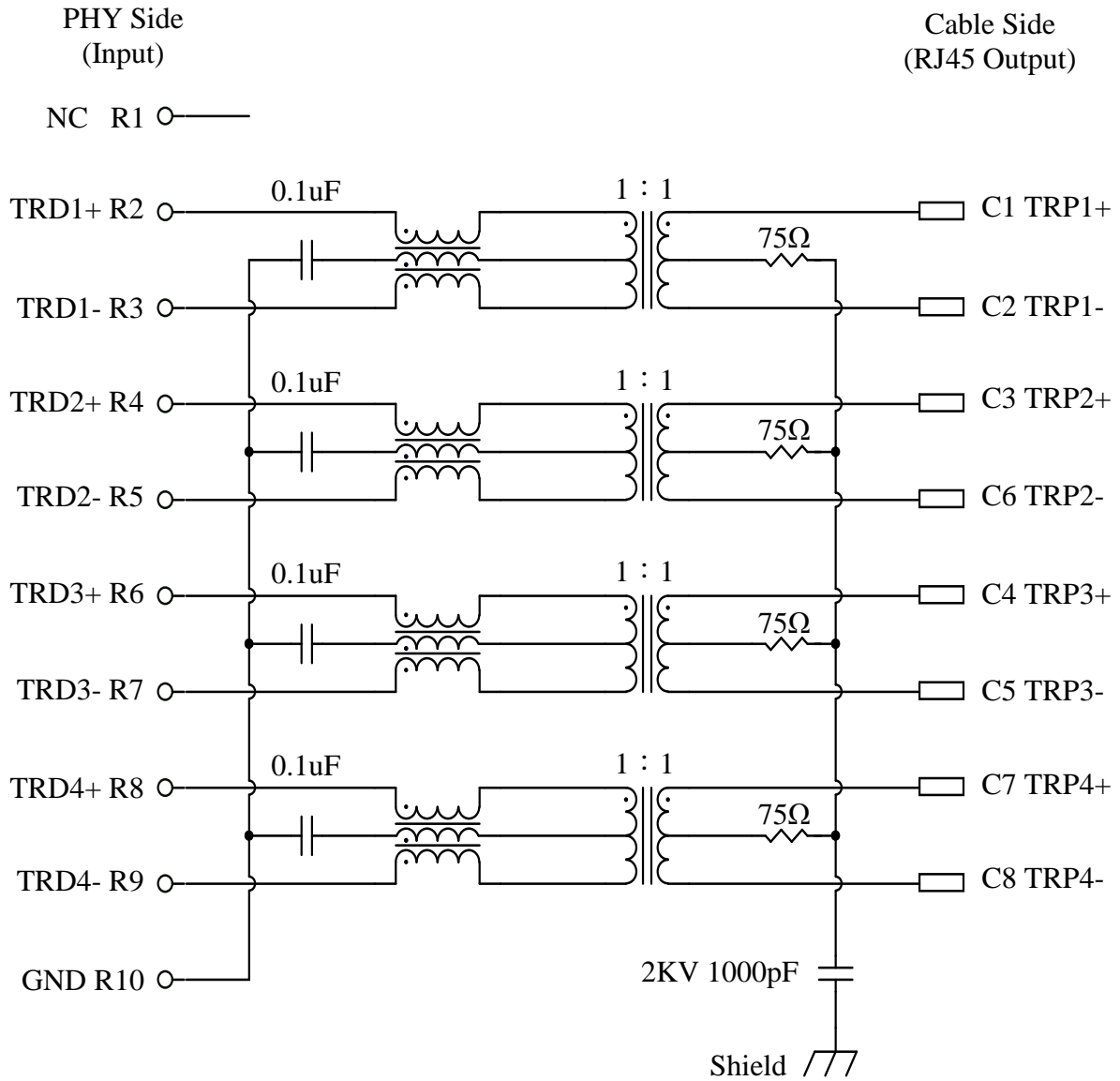
Product is designed to meet electrical, mechanical and environmental performance requirements specified in below table.

All tests are performed at ambient environmental conditions per MIL-STD-1344A and EIA-364 unless otherwise specified.

## 10 Packaging and Packing

All parts shall be packaged and packed to protect against physical damage, corrosion and deterioration during shipment and storage.

11. ELECTRICAL CHARACTERISTICS @ 25°C



Emitting Color	$\lambda_p$ (nm)	$V_f$ @ $I_f=20mA$	$I_r$ @ $V_r=5V$
Green	570	1.7 ~2.6 V	10 $\mu$ A max.
Yellow	588	1.7 ~2.6 V	10 $\mu$ A max.

## Transmitter filter &amp; Receiver filter

Type : Balance low pass 100Ω impedance

Insertion loss :	1~50MHz	-0.5dB Max.
	50~125MHz	-1.0dB Max.
	125~200MHz	-2.0dB Max.
	200~250MHz	-2.5dB Max.

Return loss :	1~50MHz	-20dB min.	load 100Ω
	50~250MHz	-20+15*log(Freq MHz/40MHz) dB Min load 100Ω	

## Reflected CM to Diff Conversion(REF)

	1MHz	-30dB min.
	50MHz	-30dB min.
	100MHz	-27dB min.
	200MHz	-24dB min.
	250MHz	-23dB min.

## CM to DM Conversion(REF)

	1~50MHz	-35dB min.
	125MHz	-30dB min.
	200MHz	-27dB min.
	250MHz	-23dB min.

## Reflected Diff to CM Conversion (REF)

	1~10MHz	-48dB min.
	10~250MHz	-48+19*log(Freq MHz/10MHz) dB Min

## CM to CM Attenuation (REF)

	1~200MHz	-25dB min.
	200~250MHz	-20dB min.

## Cross Talk (REF)

	1~125MHz	-30dB min.
	125~250MHz	-25dB min.

Inductance @ 25°C, 100KHz, 100mV, 8mA DC BIAS

Input(TRD1+ 、 TRD1-), (TRD2+ 、 TRD2-), (TRD3+ 、 TRD3-), (TRD4+ 、 TRD4-) : 160uH min.

HiPot Test

PHY Side(input) To Cable Side(output) : 1500Vac 60s or 2250Vdc 60s

12. WAVE SOLDERING TEMPERATURE PROFILE

Note :

The measuring point for the specified temperature shall be on the soldered part of the lead.

